Low-Power, Slew-Rate-Limited RS-485/RS-422 Transceivers

General Description

The HT3085 is low-power transceivers for RS-485-3.3 and RS- 422-3.3 communication. IC contains one driver and one receiver. The driver slew rates of the HT3485 is not limited, allowing them to transmit up to 2.5Mbps.

These transceivers draw between $120\mu A$ and $500\mu A$ of supply current when unloaded or fully loaded with disabled drivers. All parts operate from a single 3.3V supply. Drivers are short-circuit current limited and are protected against excessive power dissipation by thermal shutdown circuitry that places the driver outputs into a high-impedance state. The receiver input has a fail-safe feature that guarantees a logic-high output if the input is open circuit.



Features

- Low Quiescent Current: 300µA
- -7V to +12V Common-Mode Input Voltage Range
- Three-State Outputs
- 30ns Propagation Delays, 5ns Skew
- Full-Duplex and Half-Duplex Versions Available
- Operate from a Single 3.3V Supply
- Allows up to 32 Transceivers on the Bus
- Data rate: 2,5 Mbps
- Current-Limiting and Thermal Shutdown for Driver Overload Protection
- The transmitter outputs and receiver inputs are protected to ± 15 kV Air ESD.



ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V _{CC}) 7V	Continuous Power Dissipation ($T_A = +70^{\circ}C$)
Control Input Voltage -0.3V to 7V	8-Pin Plastic DIP (derate 9.09mW/°C above
	+70°C) 727mW
Driver Input Voltage (DI) -0.3V to 7V	8-Pin SOP (derate 5.88mW/°C above +70°C)
	471mW
Driver Output Voltage (A, B) -7.5V to +12.5V	Operating Temperature Ranges 0°C to +70°C
Receiver Input Voltage (A, B) -7.5V to +12.5V	Storage Temperature Range -65°C to +160°C
Receiver Output Voltage (RO) -0.3V to $(V_{CC}+0.3V)$	Lead Temperature (soldering, 10sec) +300°C

DC ELECTRICAL CHARACTERISTICS

(V_{CC} = $3.3V \pm 10\%$, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITION	NS	MIN	ТҮР	MAX	UNITS
Differential Driver Output (no load)	Vodi			2			V
Differential Driver Output	Vod2	R = 100 (RS-422)		1			V
(with load)		R = 54 (RS-485), F	igure 4	0.8			
Change in Magnitude of Driver Differential Output Voltage for Complementary Output States	ΔV od	R = 54 or 50 , Fig	ure 4			0.2	V
Driver Common-Mode Output Voltage	Voc	R = 54 or 100 , Fi	gure 4			2	V
Change in Magnitude of Driver Common-Mode Output Voltage for Complementary Output States	ΔV od	R = 54 or 100 , Fi	gure 4			0.2	V
Input High Voltage	Vih	DE, DI, RE		2.0			V
Input Low Voltage	VIL	DE, DI, RE				0.8	V
Input Current	IIN1	DE, DI, RE				±2	μΑ
Input Current	IIN2	DE = 0V;	V _{IN} =			1.0	mA
(A, B)			12V				-
		$V_{CC} = 0V \text{ or } 5.25V,$	V _{IN} = - 7V			-0.8	
Receiver Differential Threshold Voltage	VTH	$-7V \le V_{CM} \le 12V$		-0.2		0.2	V
Receiver Input Hysteresis	ΔV TH	$V_{CM} = 0V$			70		mV
Receiver Output High Voltage	Voh	$I_0 = -1.5 mA$, $VID = 2$	200mV	2.5			V
Receiver Output Low Voltage	Vol	$I_0 = 2.5 mA$, $VID = -2$	200mV			0.4	V
Three-State (high impedance) Output Current at Receiver	Iozr	$0.4V \le V_O \le 2.4V$				±1	μΑ
Receiver Input Resistance	Rin	$-7V \le V_{CM} \le 12V$		12			k

DC ELECTRICAL CHARACTERISTICS (continued)

(Vcc = $3.3V \pm 10\%$, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TY P	MAX	UNITS
No-Load Supply Current	Icc	$DE = V_{CC}$		500	800	
(Note 3)		$\overline{\text{RE}} = 0 \text{V} \text{ or } \text{V}_{\text{CC}}$		300	400	μA
		DE = 0V				
Driver Short-Circuit Current,						
	Iosdi	$-7V \le Vo \le 12V$ (Note 4)			250	mA
Vo= High						
Driver Short-Circuit Current,						
	Iosd2	$-7V \le V_0 \le 12V$ (Note 4)			250	mA
Vo=Low						
Receiver Short-Circuit Current	Iosr	$0V \le V_O \le V_{CC}$	±6.5		95	mA

SWITCHING CHARACTERISTICS

(Vcc = $3.3V \pm 10\%$, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
Driver Input to Output	t plh	$R_{DIFF} = 54\Omega$	10	30	60	ns
	t phl	$C_{L1} = C_{L2} = 100 pF$	10	30	60	
Driver Output Skew to Output	tskew	$R_{DIFF} = 54\Omega$, $CL1 = CL2 = 100 pF$		5	10	ns
Driver Enable to Output High	tzh	$C_{L}= 100 pF$, S2 closed		45	90	ns
Driver Enable to Output Low	tzl	$C_L= 100 pF$, S1 closed		45	90	ns
Driver Disable Time from Low	tlz	$C_{L}=15pF$, S1 closed		40	80	ns
Driver Disable Time from High	thz	$C_{L}=15pF$, S2 closed		40	80	ns
tPLH - tPHL Differential	tskd	$R_{DIFF} = 54\Omega$		13		ns
Receiver Skew		$C_{L1} = C_{L2} = 100 pF$				
Receiver Enable to Output Low	tzl	$C_{RL} = 15 pF$, S1 closed			50	ns
Receiver Enable to Output High	tzh	$C_{RL} = 15 pF$, S2 closed		20	50	ns
Receiver Disable Time from	tlz	$C_{RL} = 15 pF$, S1 closed		20	50	ns
Low						
Receiver Disable Time from	tHZ	$C_{RL} = 15 pF$, S2 closed		20	50	ns
High						
Maximum Data Rate	fмах		2.5			Mbps

Note 1: All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to device ground unless otherwise specified.

Note 2: All typical specifications are given for VCC = 3.3V and TA = +25°C.

Note 3: Supply current specification is valid for loaded transmitters when DE = 0V.

Note 4: Applies to peak current. See Typical Operating Characteristics.

Test Circuits





Figure 4. Driver DC Test Load



Figure 6. Driver/Receiver Timing Test Circuit





Rgure 7. Driver Timing Test Load



Operation timing diagrams of HT3485

Table of ILX 3485 operation

Transmitting				Rece	eiving			
	Inputs		Outputs X			Inputs		Outputs
RE	DE	DI	Z	Y	RE	DE	A-B	RO
Х	1	1	0	1	0	0	+0.2V	1
Х	1	0	1	0	0	0	-0.2V	0
0	0	Х	Ζ	Ζ	0	0	open	1
1	0	Х	Ζ	Ζ	1	0	Х	Ζ

X-don't care Z-high impedance

(DIP8)



	1		
	Dimens	ion, mm	
Symbol	MIN	MAX	
Α	8.51	10.16	
В	6.1	7.11	
С		5.33	
D	0.36	0.56	
F	1.14	1.78	
G	2.54		
Η	7.	62	
J	0°	10°	
K	2.92	3.81	
L	7.62	8.26	
М	0.2	0.36	
Ν	0.38		





⊕ 0.25 (0.010) ∭ T

NOTES:

1. Dimensions "A", "B" do not include mold flash or protrusions. Maximum mold flash or protrusions 0.25 mm (0.010) per side.

SOP8)			



	Dimens	sion, mm	
Symbol	MIN	MAX	
Α	4.8	5	
В	3.8	4	
С	1.35	1.75	
D	0.33	0.51	
F	0.4	1.27	
G	1.27		
Н	5	.72	
J	0°	8°	
K	0.1	0.25	
М	0.19	0.25	
Р	5.8	6.2	
R	0.25	0.5	

(



NOTES:

- 1. Dimensions A and B do not include mold flash or protrusion.
- 2. Maximum mold flash or protrusion 0.15 mm (0.006) per side for A; for B - 0.25 mm (0.010) per side.

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